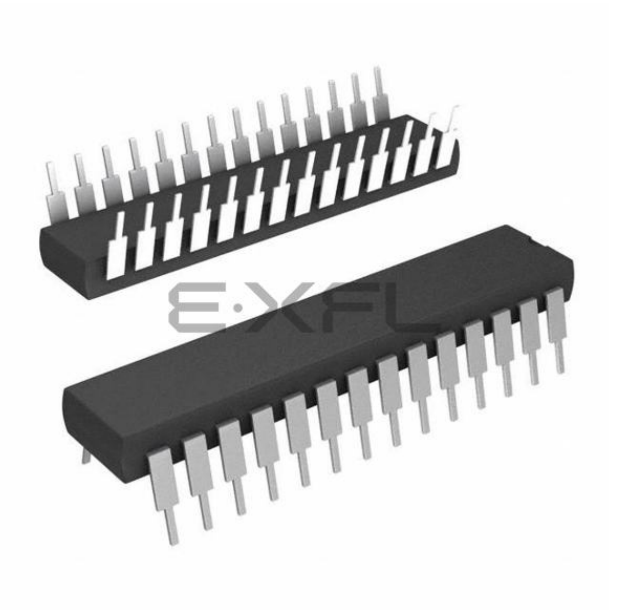
Microchip Technology - PIC18C242-E/SP Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	40MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	22
Program Memory Size	16KB (8K x 16)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	4.2V ~ 5.5V
Data Converters	A/D 5x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.300", 7.62mm)
Supplier Device Package	28-SPDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18c242-e-sp

TABLE 1-2: PIC18C2X2 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number DIP	Pin Number SOIC	Pin Type	Buffer Type	Description
					PORTC is a bi-directional I/O port.
RC0/T1OSO/T1CKI	11	11			
RC0			I/O	ST	Digital I/O.
T1OSO			O	—	Timer1 oscillator output.
T1CKI			I	ST	Timer1/Timer3 external clock input.
RC1/T1OSI/CCP2	12	12			
RC1			I/O	ST	Digital I/O.
T1OSI			I	CMOS	Timer1 oscillator input.
CCP2			I/O	ST	Capture2 input, Compare2 output, PWM2 output.
RC2/CCP1	13	13			
RC2			I/O	ST	Digital I/O.
CCP1			I/O	ST	Capture1 input/Compare1 output/PWM1 output.
RC3/SCK/SCL	14	14			
RC3			I/O	ST	Digital I/O.
SCK			I/O	ST	Synchronous serial clock input/output for SPI mode.
SCL			I/O	ST	Synchronous serial clock input/output for I^2C mode.
RC4/SDI/SDA	15	15			
RC4			I/O	ST	Digital I/O.
SDI			I	ST	SPI Data In.
SDA			I/O	ST	I^2C Data I/O.
RC5/SDO	16	16			
RC5			I/O	ST	Digital I/O.
SDO			O	—	SPI Data Out.
RC6/TX/CK	17	17			
RC6			I/O	ST	Digital I/O.
TX			O	—	USART Asynchronous Transmit.
CK			I/O	ST	USART Synchronous Clock (see related RX/DT).
RC7/RX/DT	18	18			
RC7			I/O	ST	Digital I/O.
RX			I	ST	USART Asynchronous Receive.
DT			I/O	ST	USART Synchronous Data (see related TX/CK).
VSS	8, 19	8, 19	P	—	Ground reference for logic and I/O pins.
VDD	20	20	P	—	Positive supply for logic and I/O pins.

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output
ST = Schmitt Trigger input with CMOS levels; I = Input
O = Output; P = Power
OD = Open Drain (no P diode to VDD)

TABLE 1-3: PIC18C4X2 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number			Pin Type	Buffer Type	Description
	DIP	PLCC	TQFP			
						PORTB is a bi-directional I/O port. PORTB can be software programmed for internal weak pull-ups on all inputs.
RB0/INT0	33	36	8			
RB0				I/O	TTL	Digital I/O.
INT0				I	ST	External Interrupt 0.
RB1/INT1	34	37	9			
RB1				I/O	TTL	
INT1				I	ST	External Interrupt 1.
RB2/INT2	35	38	10			
RB2				I/O	TTL	Digital I/O.
INT2				I	ST	External Interrupt 2.
RB3/CCP2	36	39	11			
RB3				I/O	TTL	Digital I/O.
CCP2				I/O	ST	Capture2 input, Compare2 output, PWM2 output.
RB4	37	41	14	I/O	TTL	Digital I/O. Interrupt-on-change pin.
RB5	38	42	15	I/O	TTL	Digital I/O. Interrupt-on-change pin.
RB6	39	43	16	I/O	TTL	Digital I/O. Interrupt-on-change pin.
				I	ST	ICSP programming clock.
RB7	40	44	17	I/O	TTL	Digital I/O. Interrupt-on-change pin.
				I/O	ST	ICSP programming data.

Legend: TTL = TTL compatible input — CMOS = CMOS compatible input or output
ST = Schmitt Trigger input with CMOS levels — I = Input
O = Output — P = Power
OD = Open Drain (no P diode to V_{DD})

3.0 RESET

The PIC18CXX2 differentiates between various kinds of RESET:

a) Power-on Reset (POR)
b) MCLR Reset during normal operation
c) MCLR Reset during SLEEP
d) Watchdog Timer (WDT) Reset (during normal operation)
e) Programmable Brown-out Reset (BOR)
f) `RESET` Instruction
g) Stack Full Reset
h) Stack Underflow Reset

Most registers are unaffected by a RESET. Their status is unknown on POR and unchanged by all other RESETS. The other registers are forced to a "RESET state" on Power-on Reset, MCLR, WDT Reset, Brown-out Reset, MCLR Reset during SLEEP, and by the `RESET` instruction.

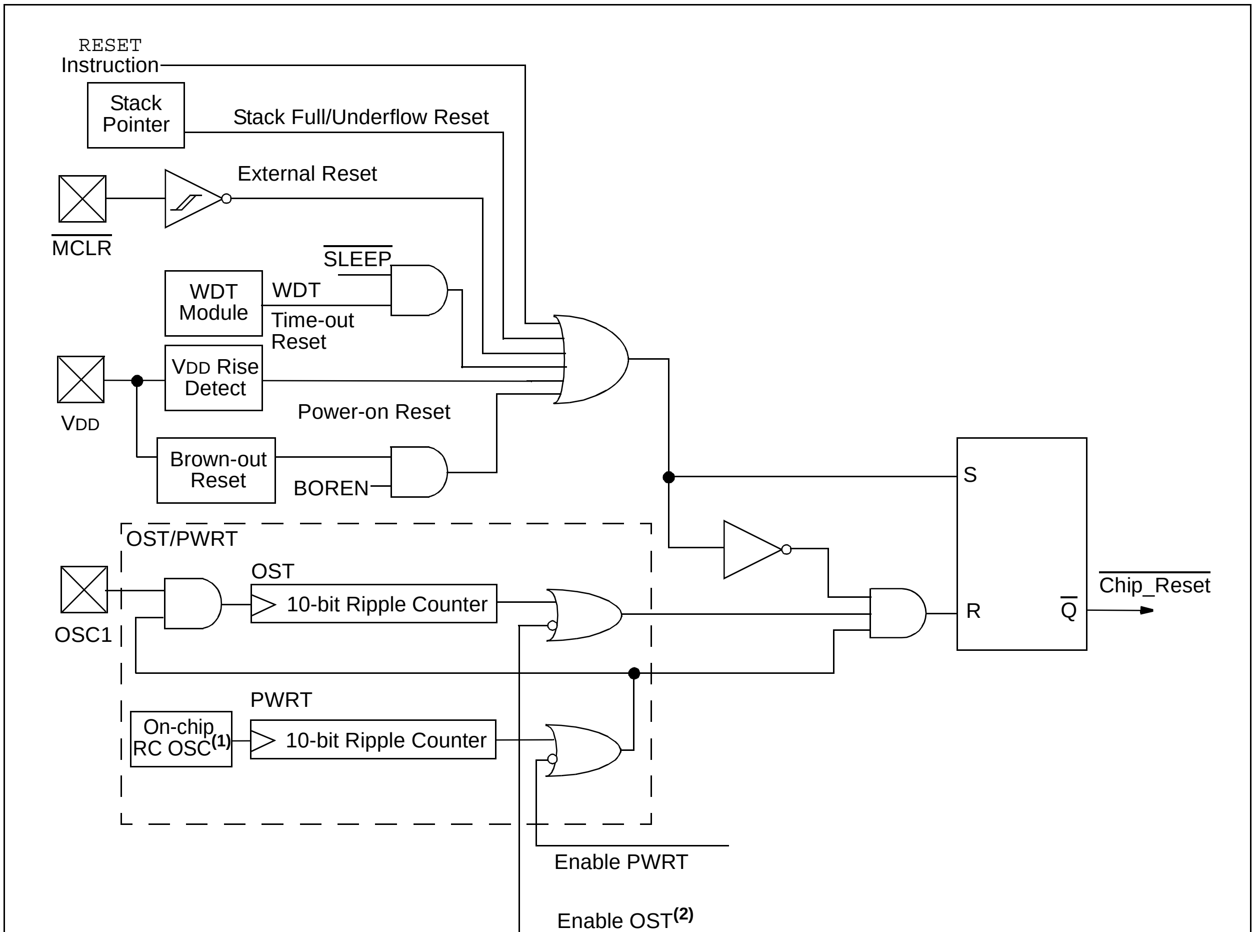
Most registers are not affected by a WDT wake-up, since this is viewed as the resumption of normal operation. Status bits from the RCON register, RI, TO, PD, POR and BOR, are set or cleared differently in different RESET situations, as indicated in Table 3-2. These bits are used in software to determine the nature of the RESET. See Table 3-3 for a full description of the RESET states of all registers.

A simplified block diagram of the On-Chip Reset Circuit is shown in Figure 3-1.

The Enhanced MCU devices have a MCLR noise filter in the MCLR Reset path. The filter will detect and ignore small pulses.

MCLR pin is not driven low by any internal RESETS, including WDT.

FIGURE 3-1: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



Note 1: This is a separate oscillator from the RC oscillator of the CLKIN pin.

2: See Table 3-1 for time-out situations.

TABLE 3-3: INITIALIZATION CONDITIONS FOR ALL REGISTERS

Register	Applicable Devices				Power-on Reset, Brown-out Reset	MCLR Resets WDT Reset RESET Instruction Stack Resets	Wake-up via WDT or Interrupt
TOSU	242	442	252	452	---0 0000	---0 0000	---0 uuuu(3)
TOSH	242	442	252	452	0000 0000	0000 0000	uuuu uuuu(3)
TOSL	242	442	252	452	0000 0000	0000 0000	uuuu uuuu(3)
STKPTR	242	442	252	452	00-0 0000	00-0 0000	uu-u uuuu(3)
PCLATU	242	442	252	452	---0 0000	---0 0000	---u uuuu
PCLATH	242	442	252	452	0000 0000	0000 0000	uuuu uuuu
PCL	242	442	252	452	0000 0000	0000 0000	PC + 2(2)
TBLPTRU	242	442	252	452	--00 0000	--00 0000	--uu uuuu
TBLPTRH	242	442	252	452	0000 0000	0000 0000	uuuu uuuu
TBLPTRL	242	442	252	452	0000 0000	0000 0000	uuuu uuuu
TABLAT	242	442	252	452	0000 0000	0000 0000	uuuu uuuu
PRODH	242	442	252	452	xxxx xxxx	uuuu uuuu	uuuu uuuu
PRODL	242	442	252	452	xxxx xxxx	uuuu uuuu	uuuu uuuu
INTCON	242	442	252	452	0000 000x	0000 000u	uuuu uuuu(1)
INTCON2	242	442	252	452	1111 -1-1	1111 -1-1	uuuu -u-u(1)
INTCON3	242	442	252	452	11-0 0-00	11-0 0-00	uu-u u-uu(1)
INDF0	242	442	252	452	N/A	N/A	N/A
POSTINC0	242	442	252	452	N/A	N/A	N/A
POSTDEC0	242	442	252	452	N/A	N/A	N/A
PREINC0	242	442	252	452	N/A	N/A	N/A
PLUSW0	242	442	252	452	N/A	N/A	N/A
FSR0H	242	442	252	452	---- 0000	---- 0000	---- uuuu
FSR0L	242	442	252	452	xxxx xxxx	uuuu uuuu	uuuu uuuu
WREG	242	442	252	452	xxxx xxxx	uuuu uuuu	uuuu uuuu
INDF1	242	442	252	452	N/A	N/A	N/A
POSTINC1	242	442	252	452	N/A	N/A	N/A
POSTDEC1	242	442	252	452	N/A	N/A	N/A
PREINC1	242	442	252	452	N/A	N/A	N/A
PLUSW1	242	442	252	452	N/A	N/A	N/A

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition

Note 1: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).

2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).

3: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

4: See Table 3-2 for RESET value for specific condition.

5: Bit 6 of PORTA, LATA, and TRISA are enabled in ECIO and RCIO oscillator modes only. In all other oscillator modes, they are disabled and read '0'.

6: The long write enable is only reset on a POR or MCLR Reset.

7: Bit 6 of PORTA, LATA and TRISA are not available on all devices. When unimplemented, they are read as '0'.

4.7.1 TWO-WORD INSTRUCTIONS

The PIC18CXX2 devices have four two-word instructions: MOVFF, CALL, GOTO and LFSR. The second word of these instructions has the 4 MSBs set to 1's and is a special kind of NOP instruction. The lower 12-bits of the second word contain data to be used by the instruction. If the first word of the instruction is executed, the data in the second word is accessed. If the second word of the instruction is executed by itself (first word was skipped), it will execute as a NOP. This action is necessary when the two-word instruction is preceded by a conditional instruction that changes the PC. A program example that demonstrates this concept is shown in Example 4-3. Refer to Section 19.0 for further details of the instruction set.

EXAMPLE 4-3: TWO-WORD INSTRUCTIONS

CASE 1:			
Object Code	**Source Code**		
0110 0110 0000 0000	TSTFSZ	REG1	; is RAM location 0?
1100 0001 0010 0011	MOVFF	REG1, REG2	; No, execute 2-word instruction
1111 0100 0101 0110			; 2nd operand holds address of REG2
0010 0100 0000 0000	ADDWF	REG3	; continue code
CASE 2:			
Object Code	**Source Code**		
0110 0110 0000 0000	TSTFSZ	REG1	; is RAM location 0?
1100 0001 0010 0011	MOVFF	REG1, REG2	; Yes
1111 0100 0101 0110			; 2nd operand becomes NOP
0010 0100 0000 0000	ADDWF	REG3	; continue code

4.8 Lookup Tables

Lookup tables are implemented two ways. These are:

- Computed GOTO
- Table Reads

4.8.1 COMPUTED GOTO

A computed GOTO is accomplished by adding an offset to the program counter (ADDWF PCL).

A lookup table can be formed with an ADDWF PCL instruction and a group of RETLW 0xnn instructions. WREG is loaded with an offset into the table, before executing a call to that table. The first instruction of the called routine is the ADDWF PCL instruction. The next instruction executed will be one of the RETLW 0xnn instructions that returns the value 0xnn to the calling function.

The offset value (value in WREG) specifies the number of bytes that the program counter should advance.

In this method, only one data byte may be stored in each instruction location and room on the return address stack is required.

4.8.2 TABLE READS/TABLE WRITES

A better method of storing data in program memory allows 2 bytes of data to be stored in each instruction location.

Lookup table data may be stored 2 bytes per program word by using table reads and writes. The table pointer (TBLPTR) specifies the byte address and the table latch (TABLAT) contains the data that is read from, or written to program memory. Data is transferred to/from program memory one byte at a time.

A description of the Table Read/Table Write operation is shown in Section 5.0.

If an indirect addressing operation is done where the target address is an FSRnH or FSRnL register, the write operation will dominate over the pre- or post-increment/decrement functions.

FIGURE 4-9: INDIRECT ADDRESSING OPERATION

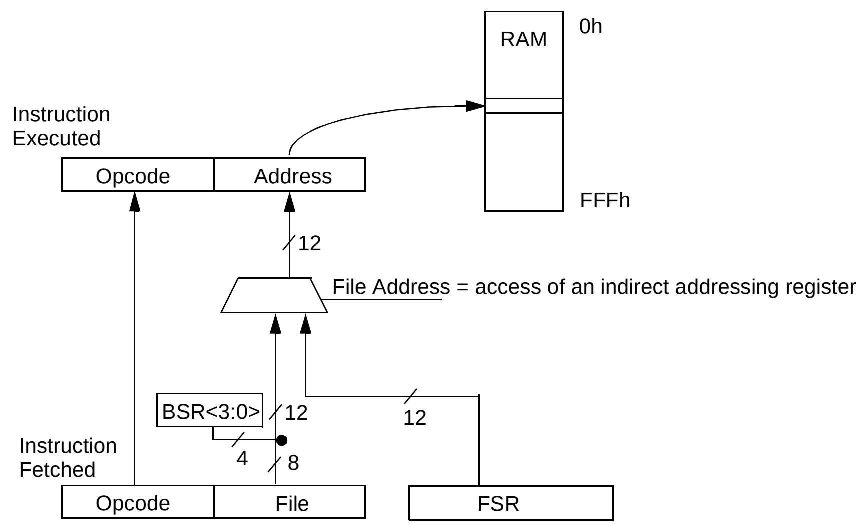
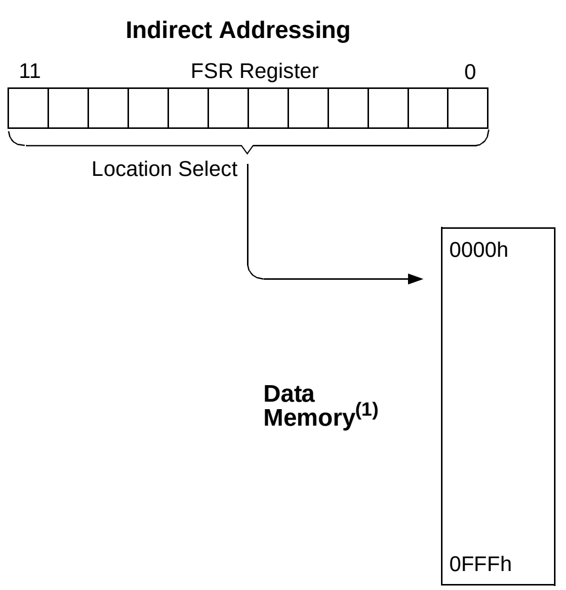


FIGURE 4-10: INDIRECT ADDRESSING



Note 1: For register file map detail, see Table 4-1.

REGISTER 7-3: INTCON3 REGISTER

R/W-1	R/W-1	U-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
INT2IP	INT1IP	—	INT2IE	INT1IE	—	INT2IF	INT1IF
bit 7							bit 0

bit 7 **INT2IP:** INT2 External Interrupt Priority bit
1 = High priority
0 = Low priority

bit 6 **INT1IP:** INT1 External Interrupt Priority bit
1 = High priority
0 = Low priority

bit 5 **Unimplemented:** Read as '0'

bit 4 **INT2IE:** INT2 External Interrupt Enable bit
1 = Enables the INT2 external interrupt
0 = Disables the INT2 external interrupt

bit 3 **INT1IE:** INT1 External Interrupt Enable bit
1 = Enables the INT1 external interrupt
0 = Disables the INT1 external interrupt

bit 2 **Unimplemented:** Read as '0'

bit 1 **INT2IF:** INT2 External Interrupt Flag bit
1 = The INT2 external interrupt occurred (must be cleared in software)
0 = The INT2 external interrupt did not occur

bit 0 **INT1IF:** INT1 External Interrupt Flag bit
1 = The INT1 external interrupt occurred (must be cleared in software)
0 = The INT1 external interrupt did not occur

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
- n = Value at POR reset	’1’ = Bit is set	’0’ = Bit is cleared	x = Bit is unknown

Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit, or the global enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

TABLE 10-2: REGISTERS ASSOCIATED WITH TIMER1 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
INTCON	GIE/GIEH	PEIE/ GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
PIR1	PSPIF(1)	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
PIE1	PSPIE(1)	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
IPR1	PSPIP(1)	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	0000 0000	0000 0000
TMR1L	Holding Register for the Least Significant Byte of the 16-bit TMR1 Register								xxxx xxxx	uuuu uuuu
TMR1H	Holding Register for the Most Significant Byte of the 16-bit TMR1 Register								xxxx xxxx	uuuu uuuu
T1CON	RD16	—	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR1ON	--00 0000	--uu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by the Timer1 module.
Note 1: The PSPIF, PSPIE and PSPIP bits are reserved on the PIC18C2X2 devices. Always maintain these bits clear.

The analog reference voltage is software selectable to either the device's positive and negative supply voltage (VDD and VSS) or the voltage level on the RA3/AN3/VREF+ pin and RA2/AN2/VREF-.

The A/D converter has a unique feature of being able to operate while the device is in SLEEP mode. To operate in SLEEP, the A/D conversion clock must be derived from the A/D's internal RC oscillator.

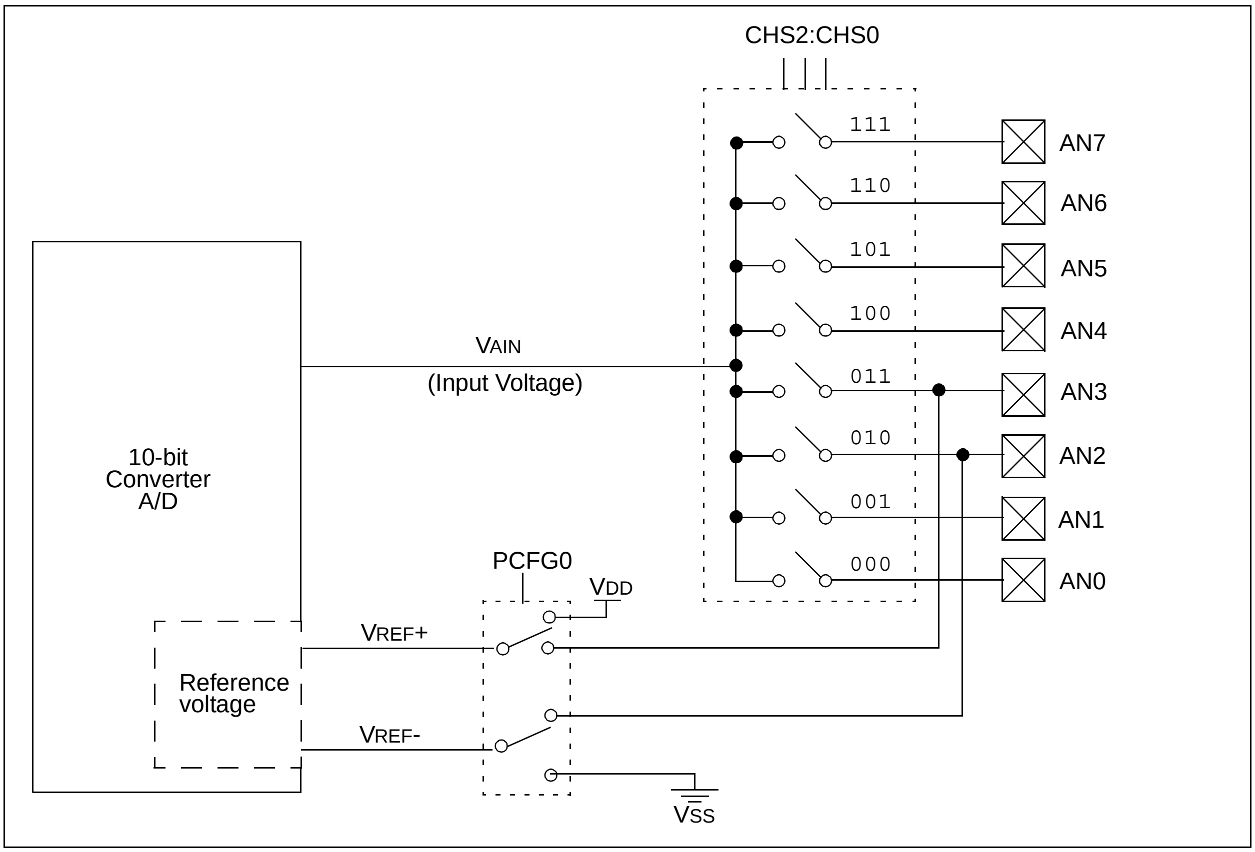
The output of the sample and hold is the input into the converter, which generates the result via successive approximation.

A device RESET forces all registers to their RESET state. This forces the A/D module to be turned off and any conversion is aborted.

Each port pin associated with the A/D converter can be configured as an analog input (RA3 can also be a voltage reference) or as a digital I/O.

The ADRESH and ADRESL registers contain the result of the A/D conversion. When the A/D conversion is complete, the result is loaded into the ADRESH/ADRESL registers, the GO/DONE bit (ADCON0<2>) is cleared, and A/D interrupt flag bit ADIF is set. The block diagram of the A/D module is shown in Figure 16-1.

FIGURE 16-1: A/D BLOCK DIAGRAM



16.4 A/D Conversions

Figure 16-3 shows the operation of the A/D converter after the GO bit has been set. Clearing the GO/DONE bit during a conversion will abort the current conversion. The A/D result register pair will NOT be updated with the partially completed A/D conversion sample. That is, the ADRESH:ADRESL registers will continue to contain the value of the last completed conversion (or the last value written to the ADRESH:ADRESL registers). After the A/D conversion is aborted, a 2TAD wait is required before the next acquisition is started. After this 2TAD wait, acquisition on the selected channel is automatically started.

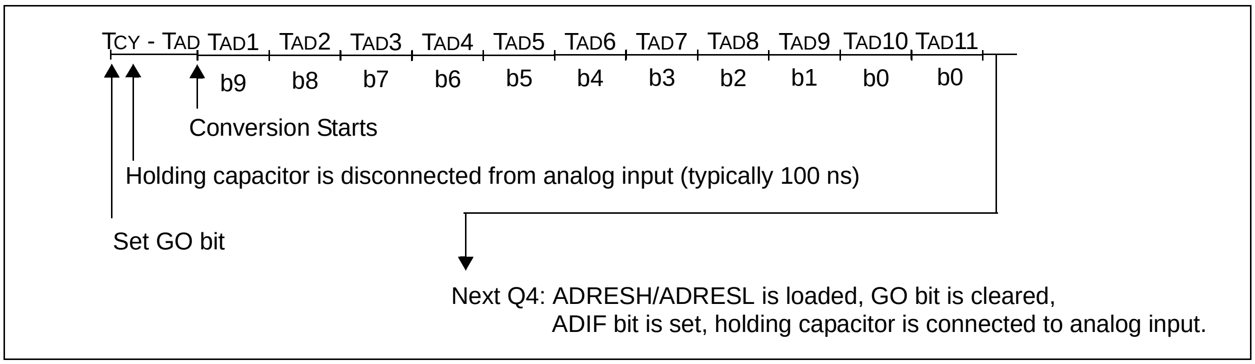
Note:	The GO/DONE bit should **NOT** be set in the same instruction that turns on the A/D.

16.5 Use of the CCP2 Trigger

An A/D conversion can be started by the "special event trigger" of the CCP2 module. This requires that the CCP2M3:CCP2M0 bits (CCP2CON<3:0>) be programmed as `1011` and that the A/D module is enabled (ADON bit is set). When the trigger occurs, the GO/DONE bit will be set, starting the A/D conversion and the Timer1 (or Timer3) counter will be reset to zero. Timer1 (or Timer3) is reset to automatically repeat the A/D acquisition period with minimal software overhead (moving ADRESH/ADRESL to the desired location). The appropriate analog input channel must be selected and the minimum acquisition done before the "special event trigger" sets the GO/DONE bit (starts a conversion).

If the A/D module is not enabled (ADON is cleared), the "special event trigger" will be ignored by the A/D module, but will still reset the Timer1 (or Timer3) counter.

FIGURE 16-3: A/D CONVERSION TAD CYCLES



17.2 Operation

Depending on the power source for the device voltage, the voltage normally decreases relatively slowly. This means that the LVD module does not need to be constantly operating. To decrease the current requirements, the LVD circuitry only needs to be enabled for short periods, where the voltage is checked. After doing the check, the LVD module may be disabled.

Each time that the LVD module is enabled, the circuitry requires some time to stabilize. After the circuitry has stabilized, all status flags may be cleared. The module will then indicate the proper state of the system.

The following steps are needed to set up the LVD module:

1. Write the value to the LVDL3:LVDL0 bits (LVDCON register), which selects the desired LVD Trip Point.
2. Ensure that LVD interrupts are disabled (the LVDIE bit is cleared, or the GIE bit is cleared).
3. Enable the LVD module (set the LVDEN bit in the LVDCON register).
4. Wait for the LVD module to stabilize (the IRVST bit to become set).
5. Clear the LVD interrupt flag, which may have falsely become set until the LVD module has stabilized (clear the LVDIF bit).
6. Enable the LVD interrupt (set the LVDIE and the GIE bits).

Figure 17-4 shows typical waveforms that the LVD module may be used to detect.

FIGURE 17-4: LOW VOLTAGE DETECT WAVEFORMS

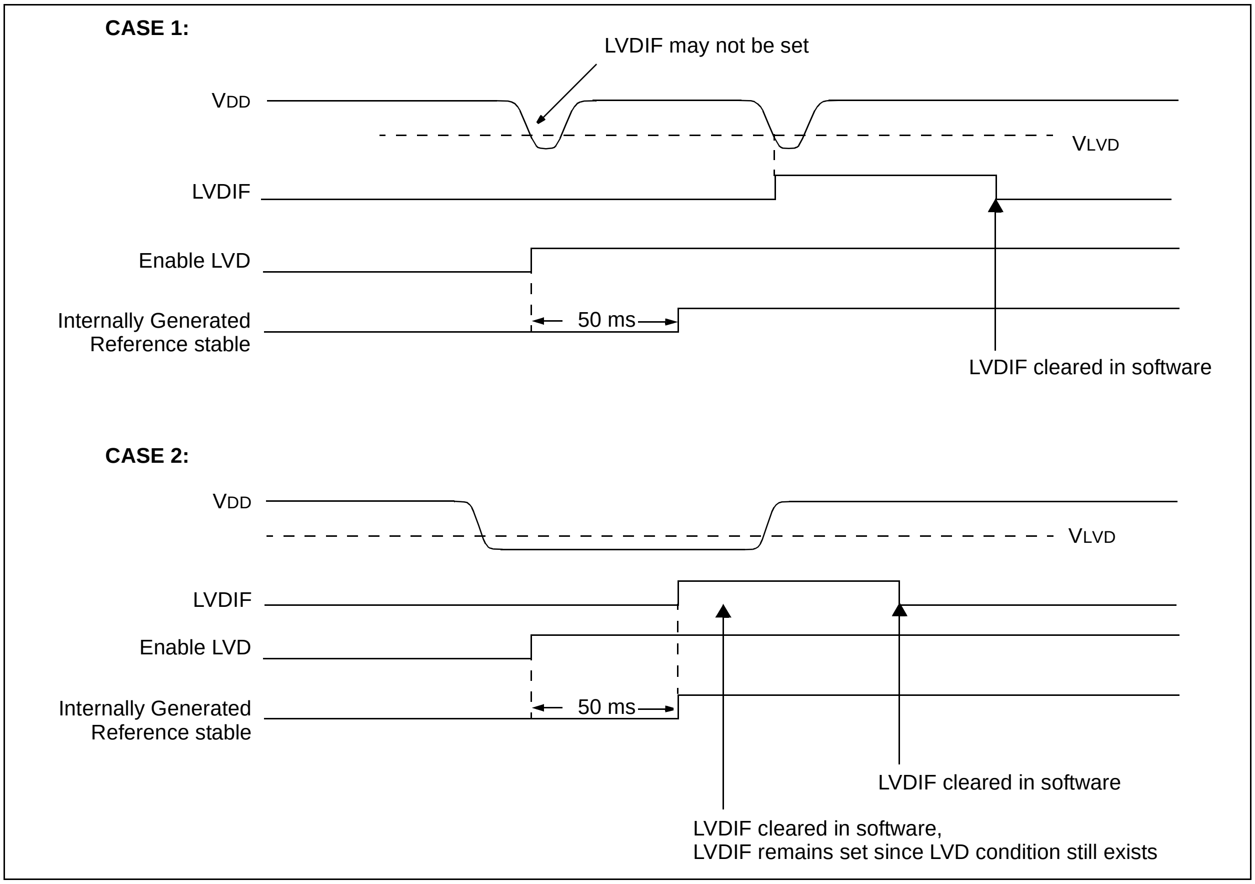


TABLE 19-2: PIC18CXXX INSTRUCTION SET

Mnemonic, Operands		Description	Cycles	16-bit Instruction Word				Status Affected	Notes
				MSb			LSb		
BYTE-ORIENTED FILE REGISTER OPERATIONS									
ADDWF	f, d, a	Add WREG and f	1	0010	01da	ffff	ffff	C, DC, Z, OV, N	1, 2
ADDWFC	f, d, a	Add WREG and Carry bit to f	1	0010	00da	ffff	ffff	C, DC, Z, OV, N	1, 2
ANDWF	f, d, a	AND WREG with f	1	0001	01da	ffff	ffff	Z, N	1,2
CLRF	f, a	Clear f	1	0110	101a	ffff	ffff	Z	2
COMF	f, d, a	Complement f	1	0001	11da	ffff	ffff	Z, N	1, 2
CPFSEQ	f, a	Compare f with WREG, skip =	1 (2 or 3)	0110	001a	ffff	ffff	None	4
CPFSGT	f, a	Compare f with WREG, skip >	1 (2 or 3)	0110	010a	ffff	ffff	None	4
CPFSLT	f, a	Compare f with WREG, skip <	1 (2 or 3)	0110	000a	ffff	ffff	None	1, 2
DECF	f, d, a	Decrement f	1	0000	01da	ffff	ffff	C, DC, Z, OV, N	1, 2, 3, 4
DECFSZ	f, d, a	Decrement f, Skip if 0	1 (2 or 3)	0010	11da	ffff	ffff	None	1, 2, 3, 4
DCFSNZ	f, d, a	Decrement f, Skip if Not 0	1 (2 or 3)	0100	11da	ffff	ffff	None	1, 2
INCF	f, d, a	Increment f	1	0010	10da	ffff	ffff	C, DC, Z, OV, N	1, 2, 3, 4
INCFSZ	f, d, a	Increment f, Skip if 0	1 (2 or 3)	0011	11da	ffff	ffff	None	4
INFSNZ	f, d, a	Increment f, Skip if Not 0	1 (2 or 3)	0100	10da	ffff	ffff	None	1, 2
IORWF	f, d, a	Inclusive OR WREG with f	1	0001	00da	ffff	ffff	Z, N	1, 2
MOVF	f, d, a	Move f	1	0101	00da	ffff	ffff	Z, N	1
MOVFF	f_s, f_d	Move f_s (source) to 1st word	2	1100	ffff	ffff	ffff	None	
		f_d (destination)2nd word		1111	ffff	ffff	ffff		
MOVWF	f, a	Move WREG to f	1	0110	111a	ffff	ffff	None	
MULWF	f, a	Multiply WREG with f	1	0000	001a	ffff	ffff	None	
NEGF	f, a	Negate f	1	0110	110a	ffff	ffff	C, DC, Z, OV, N	1, 2
RLCF	f, d, a	Rotate Left f through Carry	1	0011	01da	ffff	ffff	C, Z, N	
RLNCF	f, d, a	Rotate Left f (No Carry)	1	0100	01da	ffff	ffff	Z, N	1, 2
RRCF	f, d, a	Rotate Right f through Carry	1	0011	00da	ffff	ffff	C, Z, N	
RRNCF	f, d, a	Rotate Right f (No Carry)	1	0100	00da	ffff	ffff	Z, N	
SETF	f, a	Set f	1	0110	100a	ffff	ffff	None	
SUBFWB	f, d, a	Subtract f from WREG with borrow	1	0101	01da	ffff	ffff	C, DC, Z, OV, N	1, 2
SUBWF	f, d, a	Subtract WREG from f	1	0101	11da	ffff	ffff	C, DC, Z, OV, N	
SUBWFB	f, d, a	Subtract WREG from f with borrow	1	0101	10da	ffff	ffff	C, DC, Z, OV, N	1, 2
SWAPF	f, d, a	Swap nibbles in f	1	0011	10da	ffff	ffff	None	4
TSTFSZ	f, a	Test f, skip if 0	1 (2 or 3)	0110	011a	ffff	ffff	None	1, 2
XORWF	f, d, a	Exclusive OR WREG with f	1	0001	10da	ffff	ffff	Z, N	
BIT-ORIENTED FILE REGISTER OPERATIONS									
BCF	f, b, a	Bit Clear f	1	1001	bbba	ffff	ffff	None	1, 2
BSF	f, b, a	Bit Set f	1	1000	bbba	ffff	ffff	None	1, 2
BTFSC	f, b, a	Bit Test f, Skip if Clear	1 (2 or 3)	1011	bbba	ffff	ffff	None	3, 4
BTFSS	f, b, a	Bit Test f, Skip if Set	1 (2 or 3)	1010	bbba	ffff	ffff	None	3, 4
BTG	f, d, a	Bit Toggle f	1	0111	bbba	ffff	ffff	None	1, 2

Note 1: When a PORT register is modified as a function of itself (e.g., `MOVF PORTB, 1, 0`), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned.

3: If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a `NOP`.

4: Some instructions are 2 word instructions. The second word of these instructions will be executed as a `NOP`, unless the first word of the instruction retrieves the information embedded in these 16-bits. This ensures that all program memory locations have a valid instruction.

5: If the table write starts the write cycle to internal memory, the write will continue until terminated.

CPFSGT — Compare f with WREG, skip if f > WREG

Syntax: [*label*] CPFSGT f [,a]

Operands: $0 \leq f \leq 255$
$a \in [0,1]$

Operation: (f) – (WREG),
skip if (f) > (WREG)
(unsigned comparison)

Status Affected: None

Encoding:

0110	010a	ffff	ffff

Description: Compares the contents of data memory location 'f' to the contents of the WREG by performing an unsigned subtraction.
If the contents of 'f' are greater than the contents of WREG, then the fetched instruction is discarded and a NOP is executed instead, making this a two-cycle instruction. If ‘a’ is 0, the Access Bank will be selected, overriding the BSR value. If ‘a’ = 1, then the bank will be selected as per the BSR value (default).

Words: 1

Cycles: 1(2)
Note: 3 cycles if skip and followed by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	No operation

If skip:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation
No operation	No operation	No operation	No operation

Example:

```
HERE       CPFSGT REG, 0
NGREATER   :
GREATER    :
```

Before Instruction

```
PC     =  Address (HERE)
WREG   =  ?
```

After Instruction

```
If REG    >   WREG;
   PC     =   Address (GREATER)
If REG    ≤   WREG;
   PC     =   Address (NGREATER)
```

CPFSLT — Compare f with WREG, skip if f < WREG

Syntax: [*label*] CPFSLT f [,a]

Operands: $0 \leq f \leq 255$
$a \in [0,1]$

Operation: (f) – (WREG),
skip if (f) < (WREG)
(unsigned comparison)

Status Affected: None

Encoding:

0110	000a	ffff	ffff

Description: Compares the contents of data memory location 'f' to the contents of WREG by performing an unsigned subtraction.
If the contents of 'f' are less than the contents of WREG, then the fetched instruction is discarded and a NOP is executed instead, making this a two-cycle instruction. If ‘a’ is 0, the Access Bank will be selected. If ’a’ is 1, the BSR will not be overridden (default).

Words: 1

Cycles: 1(2)
Note: 3 cycles if skip and followed by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	No operation

If skip:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation
No operation	No operation	No operation	No operation

Example:

```
HERE    CPFSLT REG, 1
NLESS   :
LESS    :
```

Before Instruction

```
PC     =  Address (HERE)
W      =  ?
```

After Instruction

```
If REG    <   WREG;
PC        =   Address (LESS)
If REG    ≥   WREG;
PC        =   Address (NLESS)
```


DAW — Decimal Adjust WREG Register

Syntax:	[*label*] DAW
Operands:	None
Operation:	If [WREG<3:0> >9] or [DC = 1] then (WREG<3:0>) + 6 → WREG<3:0>; else (WREG<3:0>) → WREG<3:0>; If [WREG<7:4> >9] or [C = 1] then (WREG<7:4>) + 6 → WREG<7:4>; else (WREG<7:4>) → WREG<7:4>;
Status Affected:	C
Encoding:	0000 0000 0000 0111
Description:	DAW adjusts the eight-bit value in WREG, resulting from the earlier addition of two variables (each in packed BCD format) and produces a correct packed BCD result.
Words:	1
Cycles:	1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register WREG	Process Data	Write WREG

Example1: `DAW`

Before Instruction

```
WREG    =    0xA5
C       =    0
DC      =    0
```

After Instruction

```
WREG    =    0x05
C       =    1
DC      =    0
```

Example 2:

Before Instruction

```
WREG    =    0xCE
C       =    0
DC      =    0
```

After Instruction

```
WREG    =    0x34
C       =    1
DC      =    0
```

DECF — Decrement f

Syntax:	[*label*] DECF f [,d [,a]
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$
Operation:	(f) – 1 → dest
Status Affected:	C,DC,N,OV,Z
Encoding:	0000 01da ffff ffff
Description:	Decrement register 'f'. If 'd' is 0, the result is stored in WREG. If 'd' is 1, the result is stored back in register 'f' (default). If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' = 1, then the bank will be selected as per the BSR value (default).
Words:	1
Cycles:	1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

Example: `DECF    CNT,   1, 0`

Before Instruction

```
CNT     =    0x01
Z       =    0
```

After Instruction

```
CNT     =    0x00
Z       =    1
```

RLNCF — Rotate Left f (no carry)

Syntax: [*label*] RLNCF f [,d [,a]

Operands: 0 ≤ f ≤ 255
d ∈ [0,1]
a ∈ [0,1]

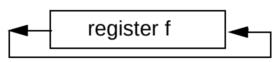
Operation: (f<n>) → dest<n+1>,
(f<7>) → dest<0>

Status Affected: N,Z

Encoding:

0100	01da	ffff	ffff

Description: The contents of register 'f' are rotated one bit to the left. If 'd' is 0, the result is placed in WREG. If 'd' is 1, the result is stored back in register 'f' (default). If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, then the bank will be selected as per the BSR value (default).



Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

Example: `RLNCF REG, 1, 0`

Before Instruction
REG = 1010 1011

After Instruction
REG = 0101 0111

RRCF — Rotate Right f through Carry

Syntax: [*label*] RRCF f [,d [,a]

Operands: 0 ≤ f ≤ 255
d ∈ [0,1]
a ∈ [0,1]

Operation: (f<n>) → dest<n-1>,
(f<0>) → C,
(C) → dest<7>

Status Affected: C,N,Z

Encoding:

0011	00da	ffff	ffff

Description: The contents of register 'f' are rotated one bit to the right through the Carry Flag. If 'd' is 0, the result is placed in WREG. If 'd' is 1, the result is placed back in register 'f' (default). If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, then the bank will be selected as per the BSR value (default).

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

Example: `RRCF REG, 0, 0`

Before Instruction
REG = 1110 0110
C = 0

After Instruction
REG = 1110 0110
WREG = 0111 0011
C = 0

21.2 DC Characteristics: PIC18CXX2 (Industrial, Extended) PIC18LCXX2 (Industrial) (Continued)

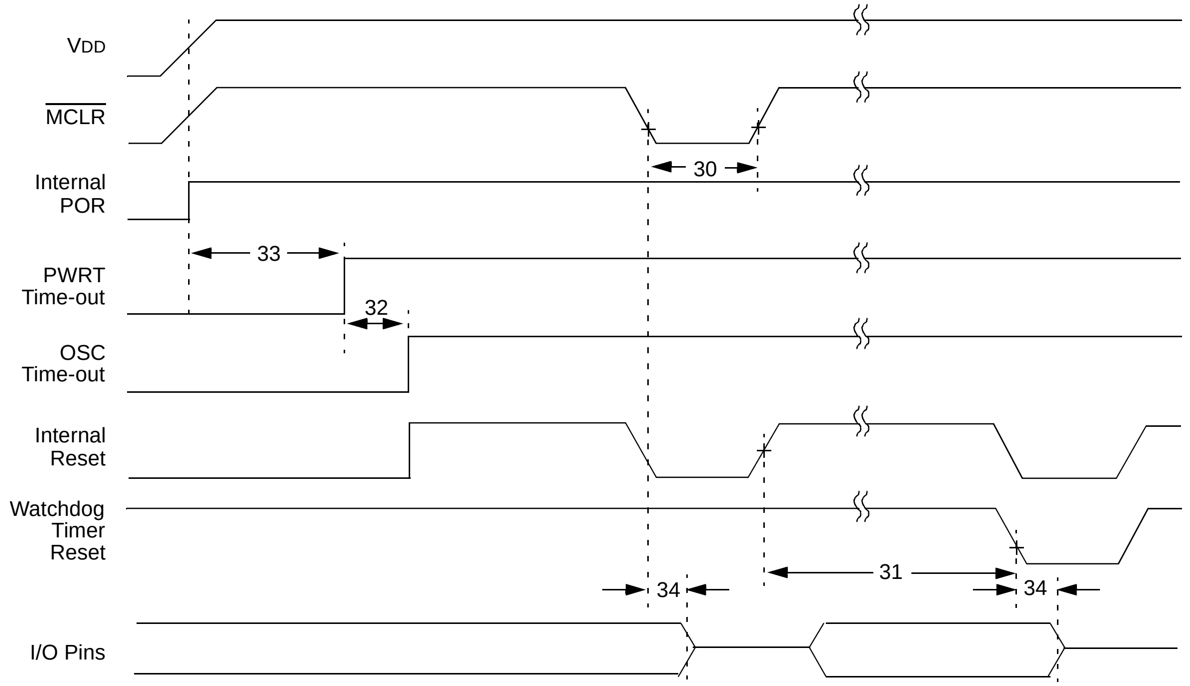
DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended			
Param No.	**Symbol**	**Characteristic**	**Min**	**Max**	**Units**	**Conditions**
	V_{OL}	**Output Low Voltage**				
D080		I/O ports	—	0.6	V	I_{OL} = 8.5 mA, V_{DD} = 4.5V, -40°C to +85°C
D080A			—	0.6	V	I_{OL} = 7.0 mA, V_{DD} = 4.5V, -40°C to +125°C
D083		OSC2/CLKOUT (RC mode)	—	0.6	V	I_{OL} = 1.6 mA, V_{DD} = 4.5V, -40°C to +85°C
D083A			—	0.6	V	I_{OL} = 1.2 mA, V_{DD} = 4.5V, -40°C to +125°C
	V_{OH}	**Output High Voltage(3)**				
D090		I/O ports	V_{DD} - 0.7	—	V	I_{OH} = -3.0 mA, V_{DD} = 4.5V, -40°C to +85°C
D090A			V_{DD} - 0.7	—	V	I_{OH} = -2.5 mA, V_{DD} = 4.5V, -40°C to +125°C
D092		OSC2/CLKOUT (RC mode)	V_{DD} - 0.7	—	V	I_{OH} = -1.3 mA, V_{DD} = 4.5V, -40°C to +85°C
D092A			V_{DD} - 0.7	—	V	I_{OH} = -1.0 mA, V_{DD} = 4.5V, -40°C to +125°C
D150	V_{OD}	**Open Drain High Voltage**	—	8.5	V	RA4 pin
		Capacitive Loading Specs on Output Pins				
D101	C_{IO}	All I/O pins and OSC2 (in RC mode)	—	50	pF	To meet the AC Timing Specifications
D102	C_B	SCL, SDA	—	400	pF	In I^{2}C mode

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC MCU be driven with an external clock while in RC mode.

2: The leakage current on the $\overline{MCLR}$ pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

FIGURE 21-7: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING



Note: Refer to Figure 21-4 for load conditions.

FIGURE 21-8: BROWN-OUT RESET TIMING

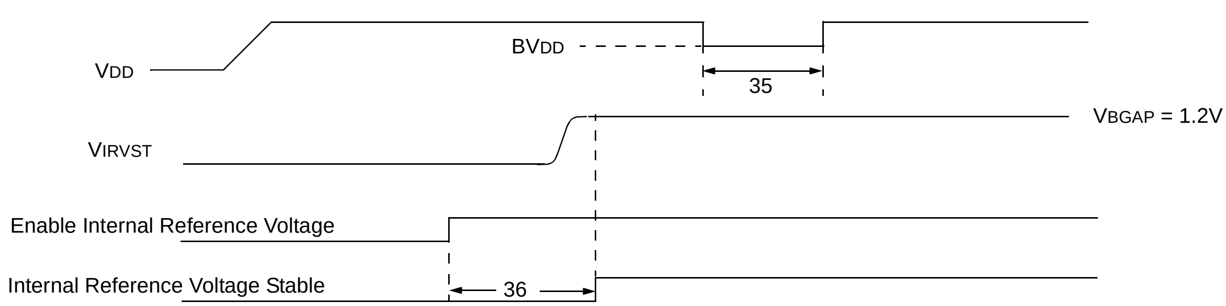
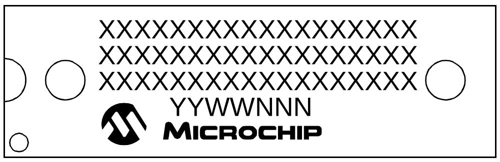


TABLE 21-7: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER AND BROWN-OUT RESET REQUIREMENTS

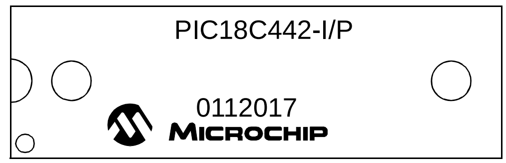
Param. No.	Symbol	Characteristic	Min	Typ	Max	Units	Conditions
30	TmcL	$\overline{MCLR}$ Pulse Width (low)	2	—	—	μs	
31	TWDT	Watchdog Timer Time-out Period (No Postscaler)	7	18	33	ms	
32	TOST	Oscillation Start-up Timer Period	1024TOSC	—	1024TOSC	—	TOSC = OSC1 period
33	TPWRT	Power up Timer Period	28	72	132	ms	
34	TIOZ	I/O Hi-impedance from $\overline{MCLR}$ Low or Watchdog Timer Reset	—	2	—	μs	
35	TBOR	Brown-out Reset Pulse Width	200	—	—	μs	VDD ≤ BVDD (See D005)
36	Tivrst	Time for Internal Reference Voltage to become stable	—	20	50	μs	

Package Marking Information (Cont'd)

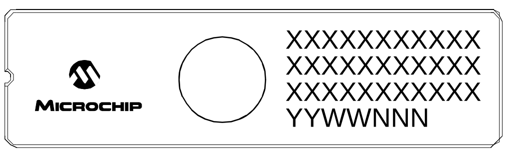
40-Lead PDIP



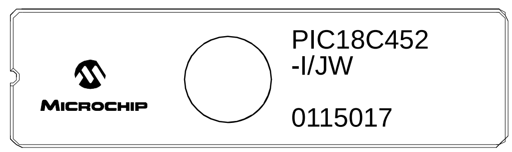
Example



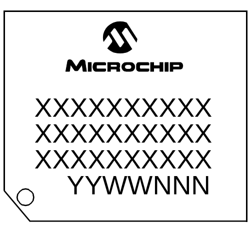
28- and 40-Lead JW (CERDIP)



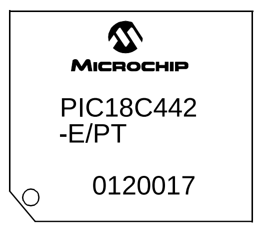
Example



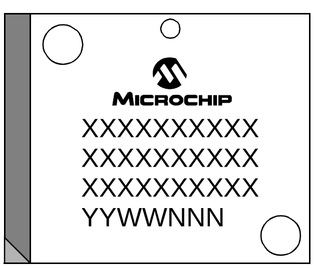
44-Lead TQFP



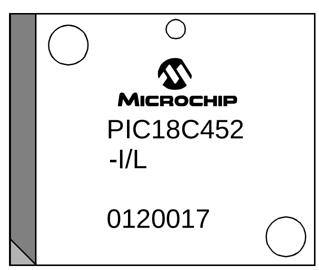
Example



44-Lead PLCC

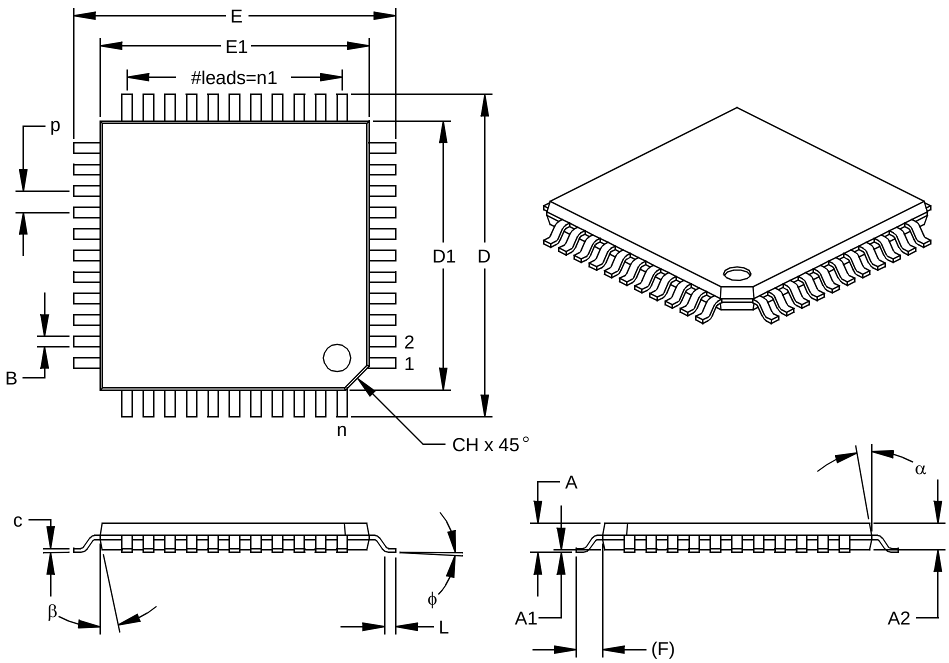


Example



44-Lead Plastic Thin Quad Flatpack (PT) 10x10x1 mm Body, 1.0/0.10 mm Lead Form (TQFP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		INCHES			MILLIMETERS*		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		44			44	
Pitch	p		.031			0.80	
Pins per Side	n1		11			11	
Overall Height	A	.039	.043	.047	1.00	1.10	1.20
Molded Package Thickness	A2	.037	.039	.041	0.95	1.00	1.05
Standoff §	A1	.002	.004	.006	0.05	0.10	0.15
Foot Length	L	.018	.024	.030	0.45	0.60	0.75
Footprint (Reference)	(F)		.039		1.00		
Foot Angle	ϕ	0	3.5	7	0	3.5	7
Overall Width	E	.463	.472	.482	11.75	12.00	12.25
Overall Length	D	.463	.472	.482	11.75	12.00	12.25
Molded Package Width	E1	.390	.394	.398	9.90	10.00	10.10
Molded Package Length	D1	.390	.394	.398	9.90	10.00	10.10
Lead Thickness	c	.004	.006	.008	0.09	0.15	0.20
Lead Width	B	.012	.015	.017	0.30	0.38	0.44
Pin 1 Corner Chamfer	CH	.025	.035	.045	0.64	0.89	1.14
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

* Controlling Parameter
§ Significant Characteristic

Notes:
Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010” (0.254mm) per side.
JEDEC Equivalent: MS-026
Drawing No. C04-076

APPENDIX A: REVISION HISTORY

Revision A (July 1999)

Original data sheet for PIC18CXX2 family.

Revision B (March 2001)

Added DC and AC characteristics graphs (Section 22.0).

Revision C (January 2013)

Added a note to each package outline drawing.

APPENDIX B: DEVICE DIFFERENCES

The differences between the devices listed in this data sheet are shown in Table 1.

TABLE 1: DEVICE DIFFERENCES

Feature	PIC18C242	PIC18C252	PIC18C442	PIC18C452
Program Memory (Kbytes)	16	32	16	32
Data Memory (Bytes)	512	1536	512	1536
A/D Channels	5	5	8	8
Parallel Slave Port (PSP)	No	No	Yes	Yes
Package Types	28-pin DIP 28-pin SOIC 28-pin JW	28-pin DIP 28-pin SOIC 28-pin JW	40-pin DIP 44-pin PLCC 44-pin TQFP 40-pin JW	40-pin DIP 44-pin PLCC 44-pin TQFP 40-pin JW